



DMT6004LPS

PowerDI

Product Summary

| BV _{DSS} | R _{DS(ON)} Max | I _D T _C = +25°C |
|-------------------|--------------------------------|--|
| 60)/ | 3.1mΩ @ V _{GS} = 10V | 90A |
| 60V | 4.5mΩ @ V _{GS} = 4.5V | 85A |

Description and Applications

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}), yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

- Primary Switch in Isolated DC-DC
- Synchronous Rectifier
- Loadswitch

Features

100% Unclamped Inductive Switching - Ensures More Reliable and Robust End Application

60V N-CHANNEL ENHANCEMENT MODE MOSFET

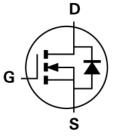
- Low R_{DS(ON)} Minimizes Power Losses
- Low Q_G Minimizes Switching Losses
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

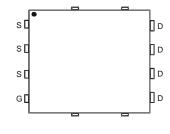
Mechanical Data

- Case: PowerDl[®]5060-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.097 grams (Approximate)









Internal Schematic

Top View Pin Configuration

Ordering Information (Note 4)

| Part Number | Case | Packaging |
|---------------|---------------|-------------------|
| DMT6004LPS-13 | PowerDI5060-8 | 2,500/Tape & Reel |

1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

Notes:



Children Characteria Control Contr T6004LS = Product Type Marking Code YYWW = Date Code Marking YY = Year (ex: 15 = 2015) WW = Week (01 to 53)

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Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit | |
|--|--|------------------|----------|----|
| Drain-Source Voltage | | V _{DSS} | 60 | V |
| Gate-Source Voltage | | V _{GSS} | ±20 | V |
| Continuous Drain Current (Note 5) | T _A = +25°C T _A = +70°C | ID | 22 16 | A |
| Continuous Drain Current (Note 6) | $T_{C} = +25^{\circ}C$ $T_{C} = +70^{\circ}C$ $(Note 8)$ | ID | 90 90 | A |
| Maximum Continuous Body Diode Forward Current (Note 6) | | Is | 90 | А |
| Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%) | | I _{DM} | 100 | А |
| Avalanche Current, L = 0.2mH | | I _{AS} | 40 | А |
| Avalanche Energy, L = 0.2mH | | E _{AS} | 160 | mJ |

Thermal Characteristic

| Characteristic | | Symbol | Value | Unit |
|--|------------------------|----------------------------------|-------------|------|
| Total Power Dissipation (Note 5) | T _A = +25°C | PD | 2.1 | W |
| Thermal Resistance, Junction to Ambient (Note 5) | | R _{0JA} | 47 | °C/W |
| Total Power Dissipation (Note 6) | T _C = +25°C | PD | 105 | W |
| Thermal Resistance, Junction to Case (Note 6) | | R _{eJC} | 1 | °C/W |
| Operating and Storage Temperature Range | | T _{J,} T _{STG} | -55 to +150 | °C |

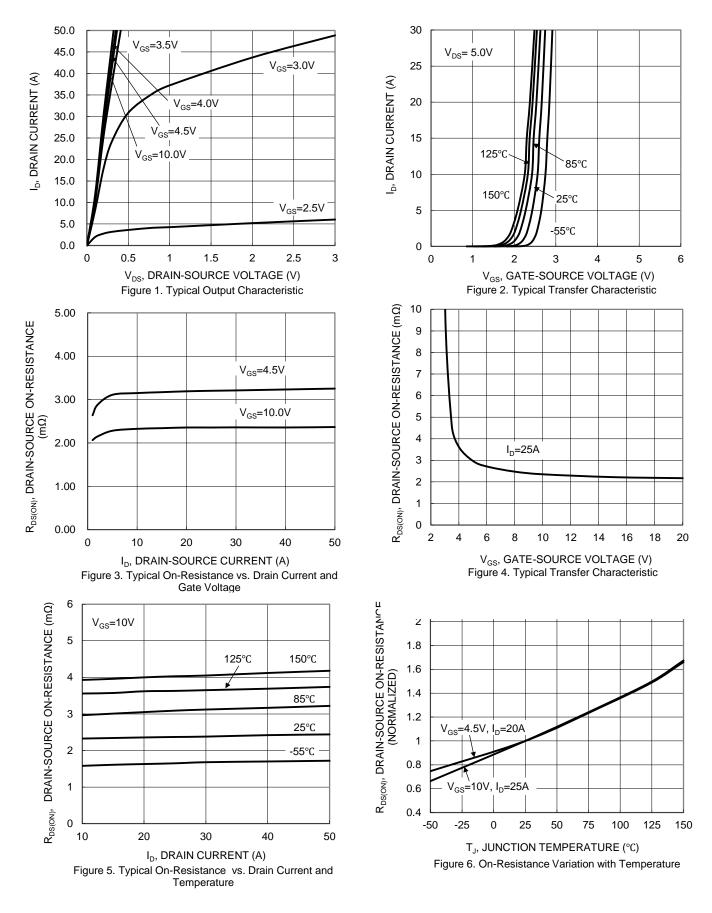
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition | |
|--|---------------------|-----|-------|------|------|---|--|
| OFF CHARACTERISTICS (Note 7) | | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | 60 | — | | V | $V_{GS} = 0V, I_D = 1mA$ | |
| Zero Gate Voltage Drain Current | I _{DSS} | — | — | 1 | μA | $V_{DS} = 48V, V_{GS} = 0V$ | |
| Gate-Source Leakage | I _{GSS} | — | _ | ±100 | nA | $V_{GS} = \pm 20V, V_{DS} = 0V$ | |
| ON CHARACTERISTICS (Note 7) | | | | | | | |
| Gate Threshold Voltage | V _{GS(TH)} | 1 | — | 3 | V | $V_{DS} = V_{GS}$, $I_D = 250 \mu A$ | |
| Static Drain-Source On-Resistance | D | _ | 2.5 | 3.1 | mΩ | $V_{GS} = 10V, I_D = 25A$ | |
| | R _{DS(ON)} | _ | 3.3 | 4.5 | mΩ | $V_{GS} = 4.5V, I_D = 20A$ | |
| Diode Forward Voltage | V _{SD} | _ | _ | 1.3 | V | $V_{GS} = 0V, I_{S} = 25A$ | |
| DYNAMIC CHARACTERISTICS (Note 8) | | | | | | | |
| Input Capacitance | CISS | _ | 4,515 | — | | $V_{DS} = 30V, V_{GS} = 0V,$ f = 1MHz | |
| Output Capacitance | Coss | — | 1,477 | _ | pF | | |
| Reverse Transfer Capacitance | C _{RSS} | _ | 135.3 | | | | |
| Gate Resistance | R _G | _ | 0.64 | _ | Ω | $V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$ | |
| Total Gate Charge (V _{GS} = 10V) | Q _G | _ | 96.3 | | | V _{DD} = 30V, I _D = 25A | |
| Total Gate Charge (V _{GS} = 4.5V) | Q _G | _ | 47.4 | _ | nC | | |
| Gate-Source Charge | Q _{GS} | _ | 14.1 | _ | nc | | |
| Gate-Drain Charge | Q _{GD} | — | 21.4 | — | | | |
| Turn-On Delay Time | t _{D(ON)} | | 9.9 | — | | $V_{DD} = 30V, V_{GS} = 10V,$ $I_D = 25A, R_G = 3.5\Omega$ | |
| Turn-On Rise Time | t _R | — | 17.7 | — | | | |
| Turn-Off Delay Time | t _{D(OFF)} | _ | 53.5 | — | ns | | |
| Turn-Off Fall Time | t _F | — | 32.9 | — | | | |
| Body Diode Reverse Recovery Time | t _{RR} | _ | 49.7 | | ns | | |
| Body Diode Reverse Recovery Charge | Q _{RR} | — | 78.9 | — | nC | – I _F = 25A, di/dt = 100A/μs | |

 Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
Thermal resistance from junction to soldering point (on the exposed drain pad). Notes:

7. Short duration pulse test used to minimize self-heating effect.
8. Guaranteed by design. Not subject to production testing.





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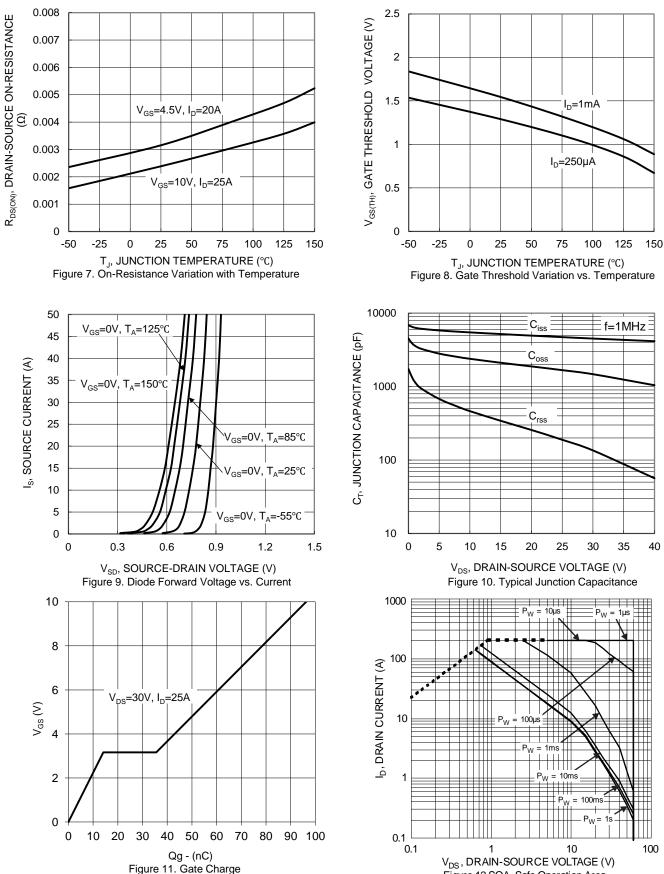
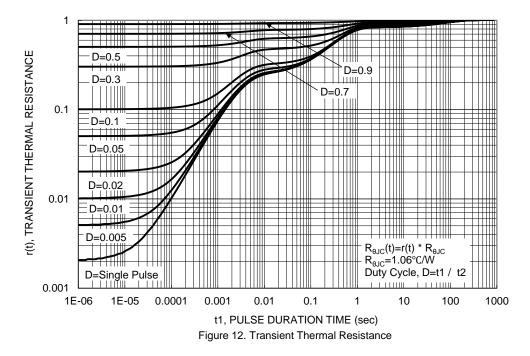


Figure 12 SOA, Safe Operation Area

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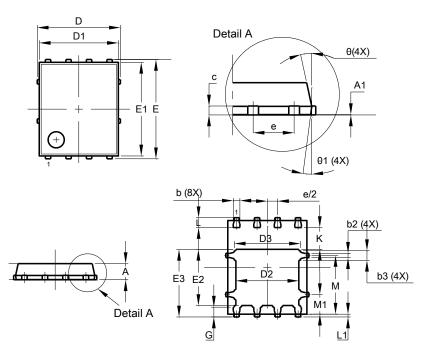






Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



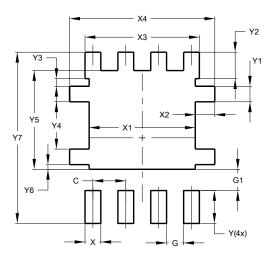
PowerDI5060-8

| | PowerDI5060-8 | | | | | |
|-----|----------------------|----------|-------|--|--|--|
| Dim | Min | Max | Тур | | | |
| Α | 0.90 | 1.10 | 1.00 | | | |
| A1 | 0.00 | 0.05 | | | | |
| b | 0.33 | 0.51 | 0.41 | | | |
| b2 | 0.200 | 0.350 | 0.273 | | | |
| b3 | 0.40 | 0.80 | 0.60 | | | |
| С | 0.230 | 0.330 | 0.277 | | | |
| D | Į | 5.15 BSC | | | | |
| D1 | 4.70 | 5.10 | 4.90 | | | |
| D2 | 3.70 | 4.10 | 3.90 | | | |
| D3 | 3.90 | 4.30 | 4.10 | | | |
| E | 6.15 BSC | | | | | |
| E1 | 5.60 | 6.00 | 5.80 | | | |
| E2 | 3.28 | 3.68 | 3.48 | | | |
| E3 | 3.99 | 4.39 | 4.19 | | | |
| е | | 1.27 BSC | | | | |
| G | 0.51 | 0.71 | 0.61 | | | |
| K | 0.51 | _ | I | | | |
| L | 0.51 | 0.71 | 0.61 | | | |
| L1 | 0.100 | 0.200 | 0.175 | | | |
| М | 3.235 | 4.035 | 3.635 | | | |
| M1 | 1.00 | 1.40 | 1.21 | | | |
| θ | 10° | 12° | 11° | | | |
| θ1 | 6° | 8° | 7° | | | |
| Al | All Dimensions in mm | | | | | |

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.

PowerDI5060-8



| Dimensions | Value (in mm) |
|------------|---------------|
| С | 1.270 |
| G | 0.660 |
| G1 | 0.820 |
| Х | 0.610 |
| X1 | 4.100 |
| X2 | 0.755 |
| X3 | 4.420 |
| X4 | 5.610 |
| Y | 1.270 |
| Y1 | 0.600 |
| Y2 | 1.020 |
| Y3 | 0.295 |
| Y4 | 1.825 |
| Y5 | 3.810 |
| Y6 | 0.180 |
| Y7 | 6.610 |



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